

MINISTRY OF EDUCATION, YOUTH AND SPORT  
HIGHER EDUCATION IMPROVEMENT PROJECT (HEIP)  
IDA-Credit No: 6221-KH

**Invitation for Bids**

**SUPPLY, DELIVERY, AND INSTALLATION OF  
SMART GRID LAB EQUIPMENT AND ITS ACCESSORIES**

1. The Kingdom of Cambodia has received a Credit from the World Bank toward the cost of Higher Education Improvement Project, Ministry of Education, Youth and Sport and it intends to apply part of the proceeds of this Credit to payments under the Contract for supply, delivery and installation of Smart Grid Lab Equipment and its Accessories. Ref: **MoEYS-HEIP-NCB-G-049**
  2. The Higher Education Improvement Project, Ministry of Education, Youth and Sport now invites sealed bids from eligible and qualified bidders for supply, delivery and installation of Smart Grid Lab Equipment and its Accessories. Ref: MoEYS-HEIP-NCB-G-049. The Bidder evaluation and qualification criteria are included in Section II of the bidding document. Bid evaluation and contract award will be on lot-wise-basis.
  3. Procurement will be conducted through National Competitive Bidding Procedures specified in the RGC's Standard Operating Procedures on Procurement for All Externally Financed Projects/Program, under the laws and regulations governing public procurement within the Kingdom of Cambodia, and in accordance with the Financing Agreement and Procurement Regulations of the World Bank.
  4. This invitation is open to all bidders.
  5. Interested eligible bidders may obtain further information and inspect the Bidding Documents at the address given below from **24 November 2021 to 27 December 2021 from 08:00 and 13:30 - 17:30 hours** (Cambodia Standard Time).
  6. For each lot, qualification requirements specified in ITB Sub-Clause 14.2 of the bidding documents include:
    - The bidder has satisfactorily completed at least two contracts for supply of similar goods in the preceding three years of a value not less than 50% of the bid price.
    - The bidder has completed contracts in the total cumulative amount equal to at least two times of the value of the bid price in the preceding two years.
    - The Manufacturer of the offered goods, if a different entity from the Bidder, has experience of at least 3 years in the manufacturing of similar goods.
    - The bidder has availability of liquid assets through either: (a) access to a line of credit or cash in bank account of an amount at least 50% of the bid price; or (b) credit terms with vendors specifically for the goods to be supplied under the contract, and valid for at least 6 months after the deadline date for submission of bids specified in ITB Clause 21.
  7. A complete set of Bidding Documents (Soft Copy) may be obtained with free-of-charge by requesting through email addresses mentioned in IFB para 12. Except for the submission of a written application through email, there shall be no other conditions for obtaining the bidding documents.
  8. In case of any difficulty in purchase of the bidding documents, interested parties may contact in writing to **H.E Mak Ngoy**, Project Manager, Higher Education Improvement Project (HEIP), # 169, Preah Norodom Blvd, Sangkat Boeung Keng Kang1, Khan Boeung Keng Kang, Phnom Penh. Tel: (855) 012 38 38 62, Tel: (855) 023 217 937. Email: [mak.ngoy@moeys.gov.kh](mailto:mak.ngoy@moeys.gov.kh) and also send a copy of the communication to:
    - (a) Director General  
General Department of International Cooperation and Debt Management  
Ministry of Economy and Finance  
Building A, 2<sup>nd</sup> Floor, Street 92, Sangkat Wat Phnom  
Khan Daun Penh, Cambodia, Fax No. (855-23) 725 341, Email: [gdicdm@mef.gov.kh](mailto:gdicdm@mef.gov.kh)
    - (b) Project Team Leader  
Mr. Simeth Beng  
Senior Education Specialist,  
The World Bank Cambodia Office.  
Exchange Square Building, No. 19-20, Street 106, Sangkat Wat Phnom, Khan Daun Penh, Phnom Penh,  
Tel: (855) 023 261366, Fax: (855) 23 261301, Email: [sbeng@worldbank.org](mailto:sbeng@worldbank.org)
  9. Bids must be delivered to the address given below at or before **9:15 a.m, 28 December 2021**.  
Late bids will be rejected. Bids will be opened in the presence of the Bidders' representatives and the project's beneficiaries from the concerned local community who choose to attend in person at the address given below at **9:15 a.m, 28 December 2021**. Bidders shall not have the option of submitting their Bids electronically.
  10. All bids shall be accompanied by a Bid Securing Declaration as described in the Instructions to Bidders.
  11. The Government and/or the Development Partner will respectively declare a bidder ineligible either indefinitely or for a stated period of time, to be awarded a contract financed by them, if it at any time they determine that the bidder has engaged in corrupt or fraudulent, coercive, collusive or obstructive practices in competing for or in executing a contract.
  12. The address referred to above are:
    - (i) Obtaining of information and collection of bidding document at: [chey.sith@moeys.gov.kh](mailto:chey.sith@moeys.gov.kh) and copy to [luon.monkol@moeys.gov.kh](mailto:luon.monkol@moeys.gov.kh), [va.sith.pu@moeys.gov.kh](mailto:va.sith.pu@moeys.gov.kh), [www.itc.edu.kh/Procurement](http://www.itc.edu.kh/Procurement), [www.moeys.gov.kh/en/procurement](http://www.moeys.gov.kh/en/procurement).
    - (ii) Submitting of bid document, and opening of bids:  
Higher Education Improvement Project (HEIP), Ministry of Education Youth and Sport (MoEYS), Project Procurement Unit's meeting room of MoEYS, New Admin Building, 2nd Floor, Street 380, Sangkat Boeng Keng Kang I, Khan Boeng Keng Kang, Phnom Penh, Cambodia.
- Attention: Mr. Chey Sith**, Deputy Director General of Administration and Finance, MoEYS and Chief of Project Procurement Unit, HEIP, New Admin Building, 2nd Floor, Street 380, Sangkat Boeng Keng Kang I, Khan Boeng Keng Kang, Phnom Penh, Cambodia. Phone: (+855) 023 726 757, 16 478 578, 12 444 401, 12 818 818, Email: [chey.sith@moeys.gov.kh](mailto:chey.sith@moeys.gov.kh) and copy to [luon.monkol@moeys.gov.kh](mailto:luon.monkol@moeys.gov.kh), [va.sith.pu@moeys.gov.kh](mailto:va.sith.pu@moeys.gov.kh)